

Technical Data Sheet 0805 Package Chip LED(1.0mm Height)

17-21/B3C-AJ0MZ/3T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain with in RoHS compliant version.

Descriptions

- The 17-21 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

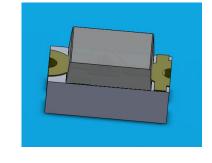
- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Part No.	Chip	Emitted Color	Resin Color	
	Material			
17-21/B3C-AJ0MZ/3T	InGaN/SiC	Blue	Water Clear	

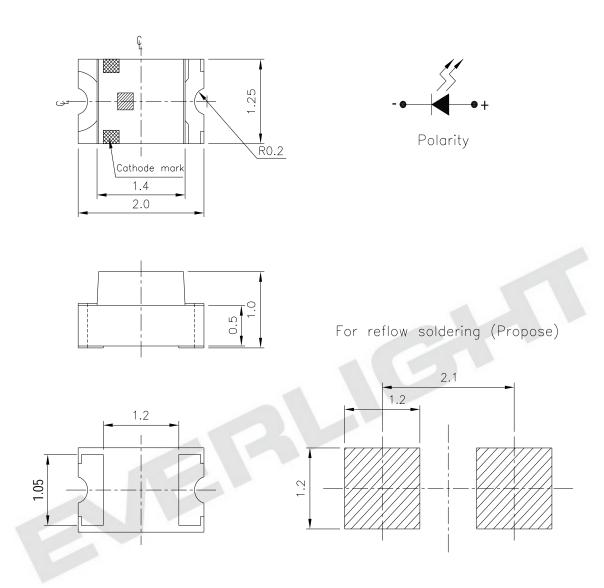
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 1 of 10

Device No.: DSE-0002755 Prepared date:16-Oct-2012 Prepared by:Shen Jianhao
Revision : 1 Release Date:2012-10-17 21:50:16.0





Package Outline Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 2 of 10

Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

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Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_{F}	30	mA
Peak Forward Current (Duty 1/10 @1KHz)	I_{FP}	100	mA
Power Dissipation	P_d	120	mW
ElectrostaticDischarge (HBM)	ESD	1000	V
Operating Temperature	Topr	-40 ~ +85	
Storage Temperature	Tstg	-40 ~ +90	
Soldering Temperature	Tsol	Reflow Soldering: 260 Hand Soldering: 350	for 10 sec for 3 sec

Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	$I_{\rm v}$	4.5		28.5	mcd	
Viewing Angle	2 1/2	-	140		deg	
Peak Wavelength	p		468		nm	
Dominant Wavelength	d	464.5		476.5	nm	I _F =10mA
Spectrum Radiation Bandwidth			26		nm	
Forward Voltage	V_{F}	2.7	3.3	3.9	V	
Reverse Current	I_R			50	μA	V _R =5V

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 10

Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

Revision : 1 Release Date:2012-10-17 21:50:16.0



Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
A	A9	464.5	467.5	nm	I _F =10mA
	A10	467.5	470.5		
	A11	470.5	473.5		
	A12	473.5	476.5		

Bin Range Of Luminous Intensity

		_ •		
Bin	Min	Max	Unit	Condition
Ј0	4.5	7.2		
K0	7.2	11.5		T 10 A
L	11.5	18.0	mcd	I _F =10mA
M	18.0	28.5		

Notes:

1.Tolerance of Luminous Intensity ±11%

2.Tolerance of Dominant Wavelength ±1nm

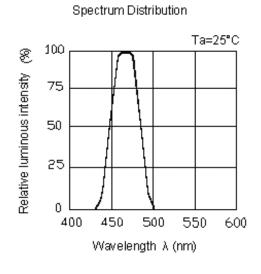
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 10

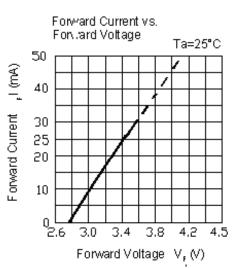
Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

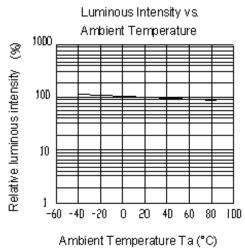
Revision : 1 Release Date:2012-10-17 21:50:16.0

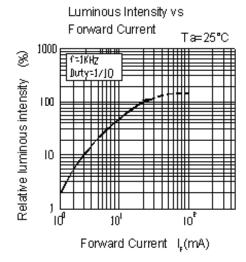


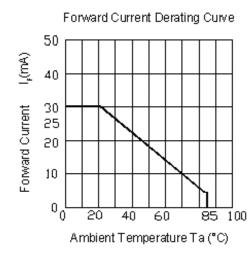
Typical Electro-Optical Characteristics Curves

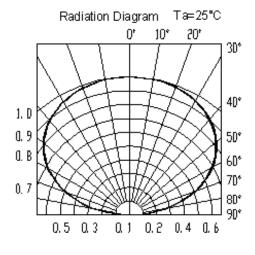












Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 5 of 10

Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

Revision : 1 Release Date:2012-10-17 21:50:16.0

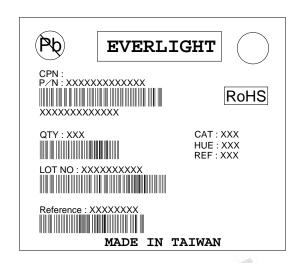


Label explanation

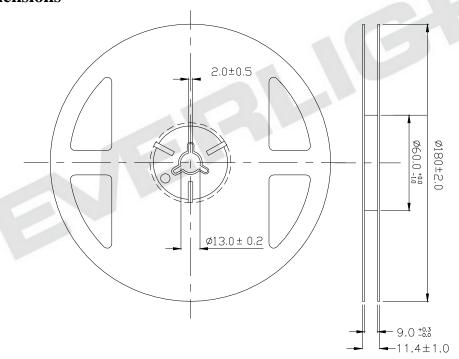
CAT: Luminous Intensity (mcd)

HUE: Dom. Wavelength (nm)

REF: Forward Voltage (V)



Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

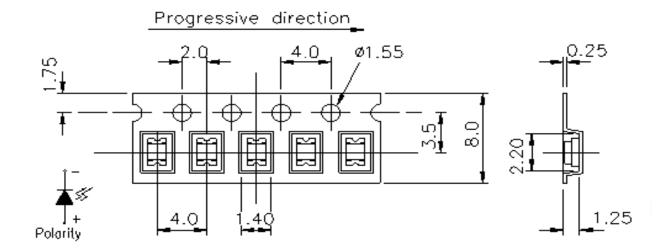
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 6 of 10

Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

Revision : 1 Release Date:2012-10-17 21:50:16.0

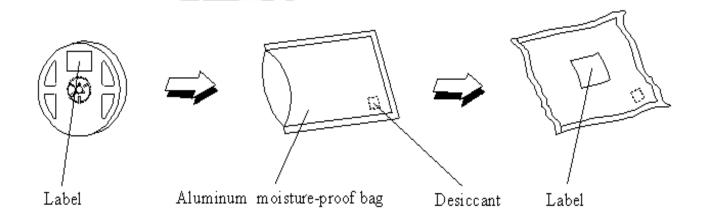


Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



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Moisture Resistant Packaging



Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 7 of 10

Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

Revision : 1 Release Date:2012-10-17 21:50:16.0



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260 ±5 Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100 15min 5 min L: -40 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H: +100 5min 10 sec L: -10 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp.: 100	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 10

Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

Revision : 1 Release Date:2012-10-17 21:50:16.0



Precautions For Use

1. Over-current-proof

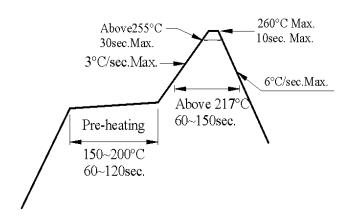
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage time

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5 for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. Rev.1 Page: 9 of 10 http://www.everlight.com Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

Release Date:2012-10-17 21:50:16.0 Revision : 1

LifecyclePhase: **Expired Period: Forever**

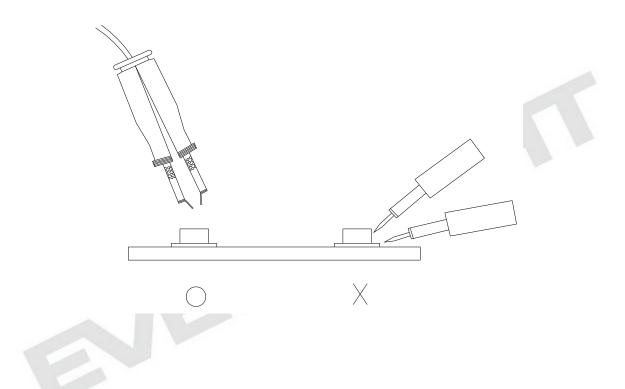


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 10 of 10

Device No.: DSE-0002755 Prepared date: 16-Oct-2012 Prepared by: Shen Jianhao

Revision : 1 Release Date:2012-10-17 21:50:16.0